## mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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## D1RFRD006

RFRD006		
		REVISION RECORD REV ECO DESCRIPTION DRFT CH
		P/N MODIFY Jake 12/07/04
		A P/N MODIFY 12/10/06 DIMENSION MODIFY APPROV
*31.6		
		× <sup>9</sup> 0
15.8	*15.0	
		$ \mathbf{\hat{e}} \mathbf{\hat{e}} \mathbf{\hat{e}} \mathbf{\hat{e}} \mathbf{\hat{e}} - \mathbf{\hat{e}} \hat$
	±0.20	
	<u>*13.2</u> 12.6	₩ 4
		*
		x 28.50
		°∕   <mark></mark>
1.02*7=7.14	1.78±0.20 🖄	PC Board Layout T=1.60mm
	5.1 4.32±0.20	
*28.5		Component Side Shown
ES:		
ECTRICAL:		
1. VOLTAGE RATING: 125 VAC RM2. CURRENT RATING: 1.5 AMP.	٨S.	
3. CONTACT RESISTANCE : 30 MILLIOHN		
4. INSULATION RESISTANCE: 1000 MEGOH 5. DIELECTRIC STRENGTH : 1000 VAC F		R <u>T NUMBER:</u> E5J88-00AJXX-L &
6. OPERATING: 750 CYCLES MIN.	AMIS OUTZ, TMIN.	G-STAMPED PIN PLATING:1-3u", H-ROUND PIN 3-15u" 4-30u", 5-50u"
CHANICAL:		H-ROUND PIN 3-15u" 4-30u"
1. HOUSING MATERIAL: NYLON+30%.2. INSERT MATERIAL: NYLON+30%.	.G.F(FR52) UL94V-0.COLOR-BLACK. .G.F(FR52) UL94V-0.COLOR-BLACK.	5–50u"
3. BACK PLATE MATERIAL : NYLON+30%.	.G.F(FR52) UL94V-0.COLOR-BLACK.	
	BRONZE Ó.35mm THICKNESS OR Ø0.46mm. NG OVER NICKEL.	
6. PCB RETENTION PRE-SOLDER : 1 LE	3 MIN.	
7. PCB RETENTION POST-SOLDER: 10 LE VIRONMENTAL:	3S MIN.	
1. STORAGE : -40°C TO +85°C.		
<ol> <li>2. OPERATION: -40°C TO +85°C.</li> <li>3. WAVE SOLDERING TEMPERRATURE: 25</li> </ol>	$5_{2}(265^{\circ}C)$ ( $5_{2}(10)$ SECONDS)	
MATES WITH MODULAR PLUG CONFORMING		
FCC PART 68, SUBPART F.	-	MM (INCH) ► DFTO Jake DATE 05/05/'04 CHKD Chi DATE 08/08/05 FILL RICE FILD OPPONIC CO ITD
CUL FILE NO. E163191		MED TZOU DATE 08/08/05 I ULU IVIJU ULUUIIVIIU UU, ULU
	0± 0. 20 0± 00. 12	20 ± TITLE ROHS
		2075 ± MATERIAL : LED GANG JACK 2 PORTS
		Ss ±         QT'Y :         Drawing no. GE5J3138         size         Ri           FINISH :         /Part no. SEE NOTE         A3
	<del>(</del> <del>(</del> <del>(</del>	T I AN NO SEL NUIE AS
	THIRD	ANGLE PROJECTION SCALE : 50:19 DO NOT SCALE DRAWING SHEET 1 OF